



**MAINTENANCE BOND OR LETTER OF CREDIT
DEVELOPMENT APPLICATION**

City of Westfield

Case No. _____

To petition the City of Westfield to initiate the process of accepting all of or a portion of a project and to begin the process of obtaining a Maintenance Bond or Letter of Credit for Maintenance the following application must be completed and submitted to:
Westfield Public Works, 2706 E 171st. Street, Westfield, Indiana 46074.

Maintenance Bond Letter of Credit

Name of project			
Description of portion of project proposed to be accepted by the City (Attach 8 1/2" x 11" map showing location)			
Contractor/Developer name	Name of primary contact	Address	Telephone number
CONSTRUCTION ACTUAL COST		Bond Number	
Streets/Curbs	\$	Streets/Curbs	
Storm sewer	\$	Storm sewer	
Sidewalk	\$	Sidewalk	
Trail	\$	Trail	
Erosion Control	\$	Erosion Control	
TOTAL	\$	Maintenance Bond or Letter of Credit Value (To be 10% of actual construction cost)	\$
Signature of Contractor/Developer			Date signed

For City use only

Execution of this Maintenance Bond or Letter of Credit for Maintenance Application by the City of Westfield signifies their acceptance of the above described project.

Date Received _____

Date of Initial Acceptance by
Board of Public Works & Safety _____

Board of Public Works & Safety

Date of final acceptance punch list
(90 days prior to bond expiration) _____

Director of Public Works

Date of bond release by City _____